Understanding Etched Foil Flexible Heaters

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May 4, 2012

*Flexible heaters* is a product family that generically describes thin and flexible heating elements that can be attached to various objects to provide freeze protection, consistent temperatures, and thermal control from -80°C to +230°C and higher. Original equipment manufacturers and after-market installers should recognize, however, that these flexible heaters are sub-divided into two primary technology platforms: etched-foil and wire-based technology. The most common technology and industry veteran is wire (wire strands woven together or single strand wire) laminated within nylon reinforced silicone rubber. These types of heaters are typically .032” thick and are used throughout many industries to attach against piping, portable drums, food warming equipment, and a host of applications, including many outdoor uses due to silicone rubber’s excellent water resistance properties. Alternatively, etched foil heaters are a relatively new technology (developed in the last 40 years) and are used in more advanced thermal management applications and/or limited thickness installations.

The basic design principles to arrive at the desired thermal performance of flexible heaters are essentially the same between etched foil and wound wire. Both utilize various resistive metals with differing resistivity characteristics. In designing a heater to a specific wattage level, manufacturers of both types of heater technologies have the option to incorporate combinations of alloys, diameters of wire (or cross sectional area), and overall length of the element to meet the customer’s defined total resistance and correlating wattage output based upon the voltage applied. There typically is not one single combination that will meet the requirement – the manufacturer of the flexible heater will select the blend of the variables that produces the most cost effective solution that meets the thermal and mechanical characteristics defined by the customer.

The primary difference between wound wire and etched foil technology is that etched foil products do not utilize a wire with a defined diameter to create the element. Instead, etched foil heaters are made with a thin foil of a specific metal alloy – a foil similar in feel to aluminum or tin foil purchased at a grocery store. Through a series of manufacturing processes, the foil is patterned and subsequently etched to create a conductive element that lies throughout the surface area of the heater body. When cross sectioned, the etched heating element is not round like a wire, but is rectangular in shape similar to a round wire being flattened out. The foil itself can be as thin as .0005” and the width of the etched foil element will typically be at least .010”.

Etched foil heater multiple heat zones.
Equivalent cross sectional areas of 19 strand .003” dia wire, solid wire, and .002” thick foil.

Just like their wound wire counterparts, designers of etched foil heaters seek to arrive at an overall resistance of the single conductive element routing through the heater shape. The above diagram shows a visual ratio of the size of a resistive wire compared to the same cross sectional area of a foil element. This is an example of a braided wire comprised of .003” strands and the relative size of an equivalent solid wire and the width of an equivalent etched foil conductor. This translates into about a 5 to 1 ratio between the overall wire diameter and the etched foil element width when using .002” foil of identical alloy.

**Etched Foil Advantages.**

Etched foil patterns, despite needing wider widths to accomplish equivalent resistance of a wire, actually permit a much tighter patterning of elements. With etched foil technology, the fabrication processes provide tight spacing control and prohibit a conductive element from coming in contact with an adjacent element. This control enables spacing between elements to be as tight as .004” which is not permissible with wire technology. This precise patterning capability translates into even thermal distribution – one of the driving reasons designers utilize etched foil heaters. Additionally, since the element pattern is photo-lithography processed, precise repeatability of the heating element is provided.

The thermal control and thermal precision of etched foil heaters is also due to the large surface area of the etched element. Compared to wire where heat is transferred via a tangent point or an arc area of the circular element, the flat surface area of an etched element provides uniform and significantly more surface for the heat to transfer to the mating heat sink effectively and efficiently. Wire-based heaters typically need to run hotter to make up for this difference.

Other reasons to utilize etched foil heaters include the overall thickness of the heater package. Etched foil heaters can be produced with thinner materials such as polyimide (DuPont Kapton® for example), enabling etched foil heaters to be produced with an overall thickness of .005” compared to traditional silicone rubber wound wire heaters at .032” thick or more. This thickness advantage is highlighted by etched foil’s ability to provide heating in a small packages and around tight bend radius mounting surfaces.
Ultra fine element widths and spacing is possible with etched foil heaters. Shown here are .003" wide elements with .003" spacing.

Another valuable aspect of etched foil technology is that these types of heaters can easily incorporate components because the devices can be soldered directly to the heater foil using traditional soldering technologies. Not only does this type of design permit adding of single components such as thermisters and fuses, but it also enables a portion of the heater to be designed with an integral flexible printed circuit board which can provide control logic for other components within the system.

**Etched Foil Fabrication.**

The fabrication processes of creating etched foil heaters have many similarities to the techniques of the paper conversion industry. However, polyimide films are unstable and are somewhat unpredictable in their physical dimensional properties and this introduces processing variability that must be accounted for. The material can shrink and expand to some degree with changes in humidity and temperature, the material can have fluctuating thicknesses throughout fabrication lots, and the material can have inconsistent material stability in the X-Y axis across a square area.

The fabrication steps to create an etched foil heater follows this common sequence:

1. **Creation of the Base Laminate.** The initial step in fabricating a heater is to select and then laminate the foil to the base substrate (polyimide in this example). This often is accomplished by using a thin thermosetting adhesive layer that has excellent adhesion properties with the two materials being bonded. This adhesive layer must also maintain integrity for subsequent fabrication processes, such as chemical etching, and it must also maintain integrity to satisfy customer performance requirements for the application, such as out-gassing, UL flame retardancy, mechanical flexing, and a variety of other customer-specific requirements. The selection of the material composite is an essential factor in ensuring the heater is successful in the application.

The lamination cycle of the base laminate is typically done under pressure and temperature for an extended period of time, using appropriate compliant materials within the press chamber to promote high bond and peel strengths.
2. **Drilling of Registration Holes.** In order for the fabrication processes and the multiple layers within the heater to keep in alignment with one another, tooling holes are often drilled into the base laminate.

3. **Imaging.** This stage involves multiple process steps in order to create the pattern of the conductive element onto the base laminate. The first step is to laminate or coat a photo-imageable resist onto the panel. After that is complete with satisfactory adhesion, a high grade photo mask tool is placed over the resist. This mask has been generated from CAD design tools and represents the end-design of the heating element, including the applicable element width needed to produce the correct resistance of the heater.

   This pair is then subjected to a photo-exposing process, where the resist is exposed to UV light and is cured to serve as a chemical etch resist. The cured resist protects the heater element pattern while the non-cured resist is removed, exposing the foil for etching and the foil’s removal.

   **Etching.** The panel is now presented to a series of chemical etching, stripping, and cleaning processes so that the foil that has not been protected by the resist is chemically removed and the heating element pattern remains on the panel.

   The etchant chemicals used for this process vary depending upon the particular foil that is being etched. Alkaline-based etchants are used for copper alloys, while alternative etchant chemistries are used for stainless steel and foils with

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Tooting/registration holes

Artwork

Cured resist on base laminate – ready for etching

Etched heater panel
iron. The control parameters during etching are precisely defined and maintained for the foil type, thickness, and pattern density.

The controls of this process directly contribute to the individual heater element’s finished ‘conductor width’. Naturally, the resulting conductor width directly ties to the heater’s overall resistance. Normal variance in the etching process can result in a resistance tolerance of up to 10% for fine-line elements and but can be tighter for wider elements.

Resistance testing and validation is typically done at this stage in the fabrication sequence.

4. **Top Dielectric Lamination.** The next process sequence is to apply a top dielectric (coverlay) to the panel. This top film, also a polyimide, has a high-performance adhesive coating on one side. Prior to laminating the coverlay, the film is drilled in a correlating pattern to match the heater pattern and tooling holes in the base laminate. Access openings to the heating element are provided by this coverlay, including openings where wires and components are attached.

This coverlay film is laminated over the top of the etched panel by a similar pressing cycle as the original base laminate. Differing compliant materials during pressing are used so that the film can conform over the etch pattern without introducing voids or air entrapment.

5. **Optional Back Side PSA.** If the customer desires, at this stage, pressure sensitive adhesive (PSA) is placed onto the rear surface of the panel. The PSA may be pre-cut to different shapes so that portions of the PSA are not on areas of the heater that the customer specifies.

The most common pressure sensitive adhesive is .002” thick and is shipped with a release liner for the customer to remove during installation. The adhesive reaches its highest bond strength in approximately 72 hours after being pressed into place.
6. **Excising.** The final fabrication step is to remove the completed part from the panel. This is commonly done with steel rule dies. Tolerances and capabilities of steel rule dies are taken into account during the design phase but general variation in cutline dimensions are specified at +/- .010”.

7. **Assembly.** After the heater has been excised from the panel, it is now ready for final assembly of wires, custom marking, adding of components, assembly onto heat sinks, or any other finishing steps that are desired by the customer.

**Choices for Designers.**

Flexible heaters are an excellent and affordable source of heating for freeze protection, viscosity control, process control and condensation control. The thin profile provides the ability to wrap and conform to three dimensional objects while enabling good thermal transfer to mating surfaces. Furthermore, flexible heaters have their own design and construction options depending upon the specific needs of the application, providing designers with choices for their flexible heaters. Whether selecting wire-based technology or etched-foil technologies, both have benefits that come into play to solve the thermal challenge. Utilize the manufacturer’s expertise to arrive at the best system for the application.